

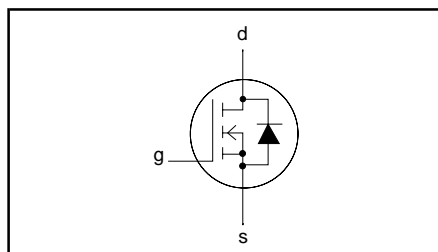
**N-channel TrenchMOS™ transistor
Logic level FET**

**PHP50N03LT, PHB50N03LT
PHD50N03LT**

FEATURES

- 'Trench' technology
- Very low on-state resistance
- Fast switching
- High thermal cycling performance
- Low thermal resistance
- Logic level compatible

SYMBOL



QUICK REFERENCE DATA

$V_{DSS} = 25\text{ V}$
$I_D = 48\text{ A}$
$R_{DS(ON)} \leq 16\text{ m}\Omega (V_{GS} = 10\text{ V})$
$R_{DS(ON)} \leq 21\text{ m}\Omega (V_{GS} = 5\text{ V})$

GENERAL DESCRIPTION

N-channel enhancement mode logic level field-effect power transistor in a plastic envelope using 'trench' technology.

Applications:-

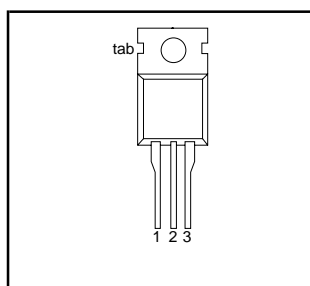
- High frequency computer motherboard d.c. to d.c. converters
- High current switching

The PHP50N03LT is supplied in the SOT78 (TO220AB) conventional leaded package.
The PHB50N03LT is supplied in the SOT404 (D²PAK) surface mounting package.
The PHD50N03LT is supplied in the SOT428 (DPAK)surface mounting package.

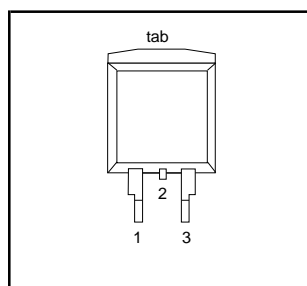
PINNING

PIN	DESCRIPTION
1	gate
2	drain ¹
3	source
tab	drain

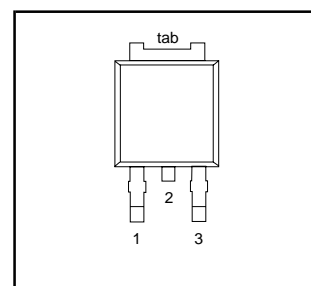
SOT78 (TO220AB)



SOT404 (D²PAK)



SOT428 (DPAK)



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DSS}	Drain-source voltage	$T_j = 25\text{ }^\circ\text{C}$ to $175\text{ }^\circ\text{C}$	-	25	V
V_{DGR}	Drain-gate voltage	$T_j = 25\text{ }^\circ\text{C}$ to $175\text{ }^\circ\text{C}$; $R_{GS} = 20\text{ k}\Omega$	-	25	V
V_{GS}	Gate-source voltage (DC)		-	± 15	V
V_{GSM}	Gate-source voltage (pulse peak value)	$T_j \leq 150\text{ }^\circ\text{C}$	-	± 20	V
I_D	Drain current (DC)	$T_{mb} = 25\text{ }^\circ\text{C}$	-	48	A
		$T_{mb} = 100\text{ }^\circ\text{C}$	-	34	A
I_{DM}	Drain current (pulse peak value)	$T_{mb} = 25\text{ }^\circ\text{C}$	-	180	A
P_{tot}	Total power dissipation	$T_{mb} = 25\text{ }^\circ\text{C}$	-	86	W
T_j, T_{stg}	Operating junction and storage temperature		- 55	175	$^\circ\text{C}$

¹ It is not possible to make connection to pin:2 of the SOT404 or SOT428 packages.

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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th\ j-mb}$	Thermal resistance junction to mounting base		-	-	1.75	K/W
$R_{th\ j-a}$	Thermal resistance junction to ambient	SOT78 package, in free air SOT404 and SOT428 packages, pcb mounted, minimum footprint	-	60	-	K/W
			-	50	-	K/W

AVALANCHE LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
W_{DSS}	Drain-source non-repetitive unclamped inductive turn-off energy	$I_D = 25\text{ A}$; $V_{DD} \leq 15\text{ V}$; $V_{GS} = 5\text{ V}$; $R_{GS} = 50\ \Omega$; $T_{mb} = 25\text{ °C}$	-	60	mJ

ELECTRICAL CHARACTERISTICS

$T_j = 25\text{ °C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0\text{ V}$; $I_D = 0.25\text{ mA}$; $T_j = -55\text{ °C}$	25	-	-	V
			22	-	-	V
$V_{GS(TO)}$	Gate threshold voltage	$V_{DS} = V_{GS}$; $I_D = 1\text{ mA}$ $T_j = 175\text{ °C}$	1	1.5	2	V
		$T_j = -55\text{ °C}$	0.5	-	-	V
			-	-	2.3	V
$R_{DS(ON)}$	Drain-source on-state resistance	$V_{GS} = 10\text{ V}$; $I_D = 25\text{ A}$ $V_{GS} = 10\text{ V}$; $I_D = 25\text{ A}$ (SOT428 package) $V_{GS} = 5\text{ V}$; $I_D = 25\text{ A}$ $V_{GS} = 5\text{ V}$; $I_D = 25\text{ A}$; $T_j = 175\text{ °C}$	-	13	16	m Ω
			-	15	18	m Ω
			-	18	21	m Ω
			-	-	39	m Ω
g_{fs}	Forward transconductance	$V_{DS} = 25\text{ V}$; $I_D = 25\text{ A}$	8	27	-	S
I_{DSS}	Zero gate voltage drain current	$V_{DS} = 25\text{ V}$; $V_{GS} = 0\text{ V}$; $T_j = 175\text{ °C}$	-	0.05	10	μA
			-	-	500	μA
I_{GSS}	Gate source leakage current	$V_{GS} = \pm 5\text{ V}$; $V_{DS} = 0\text{ V}$	-	10	100	nA
$Q_{g(tot)}$	Total gate charge	$I_D = 50\text{ A}$; $V_{DD} = 15\text{ V}$; $V_{GS} = 5\text{ V}$	-	17	-	nC
Q_{gs}	Gate-source charge		-	7.6	-	nC
Q_{gd}	Gate-drain (Miller) charge		-	11	-	nC
$t_{d\ on}$	Turn-on delay time	$V_{DD} = 15\text{ V}$; $I_D = 25\text{ A}$;	-	6.4	12	ns
t_r	Turn-on rise time	$V_{GS} = 10\text{ V}$; $R_G = 5\ \Omega$	-	62	75	ns
$t_{d\ off}$	Turn-off delay time	Resistive load	-	50	75	ns
t_f	Turn-off fall time		-	30	45	ns
L_d	Internal drain inductance	Measured tab to centre of die	-	3.5	-	nH
L_d	Internal drain inductance	Measured from drain lead to centre of die (SOT78 package only)	-	4.5	-	nH
L_s	Internal source inductance	Measured from source lead to source bond pad	-	7.5	-	nH
C_{iss}	Input capacitance	$V_{GS} = 0\text{ V}$; $V_{DS} = 25\text{ V}$; $f = 1\text{ MHz}$	-	1050	-	pF
C_{oss}	Output capacitance		-	330	-	pF
C_{rss}	Feedback capacitance		-	220	-	pF

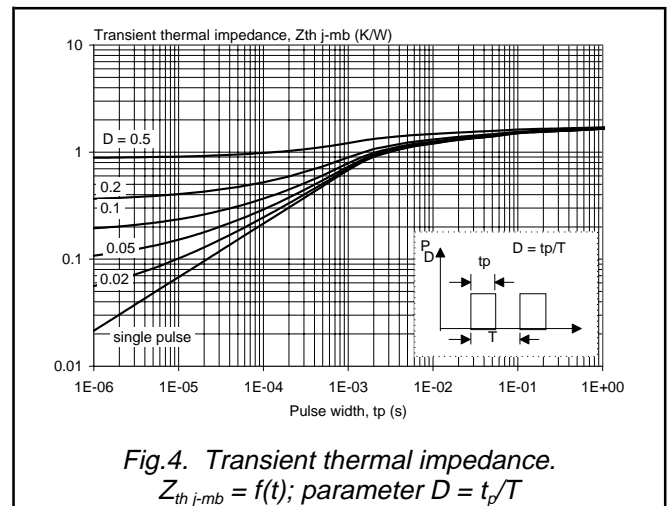
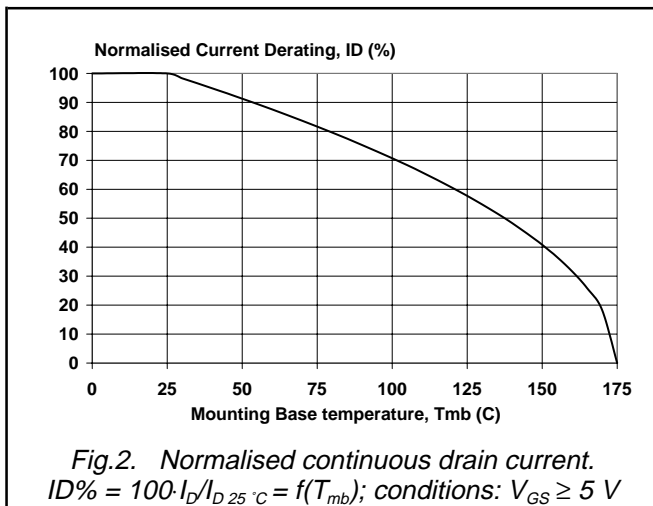
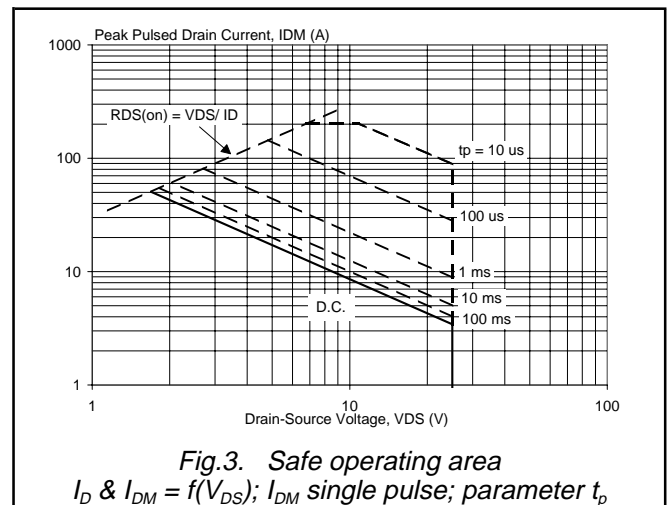
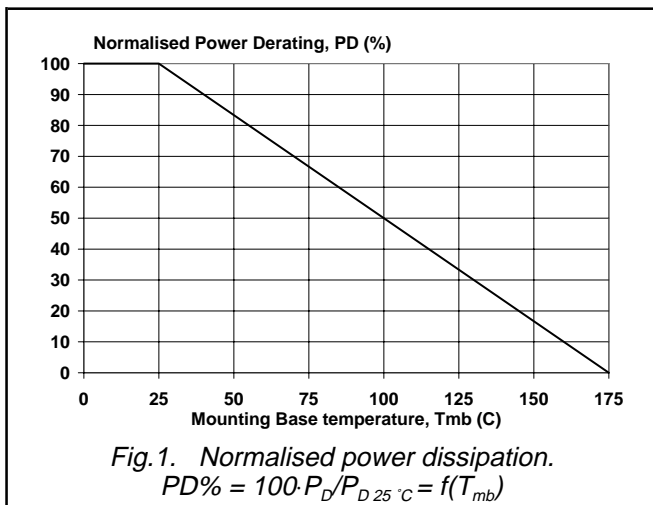
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REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS

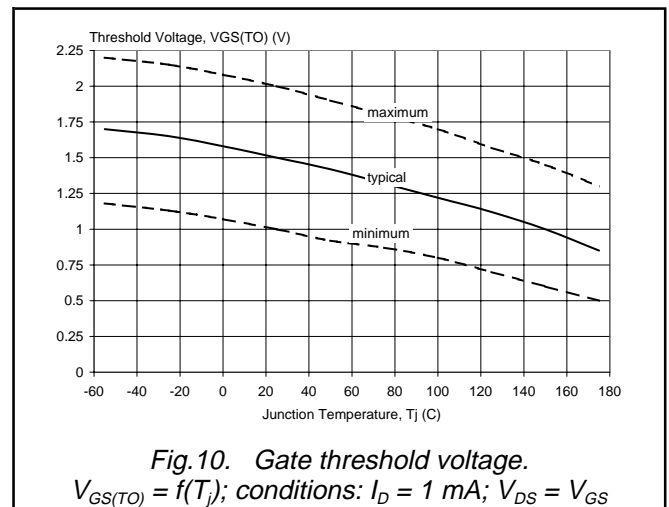
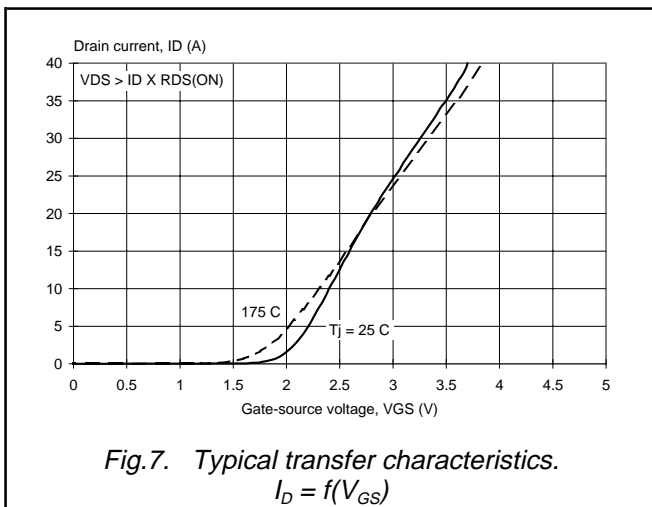
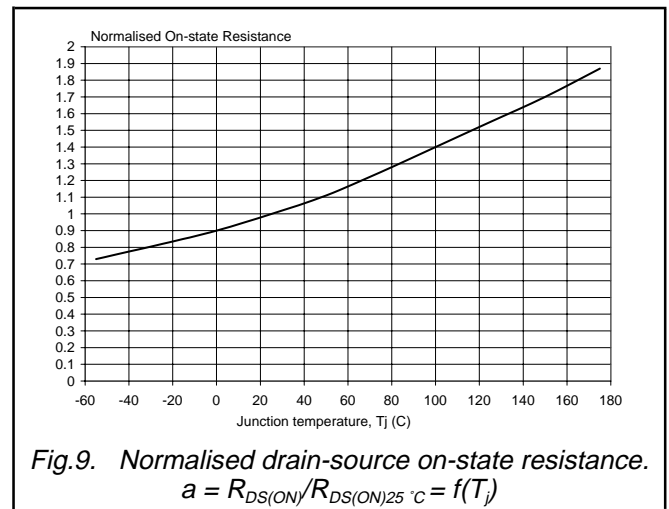
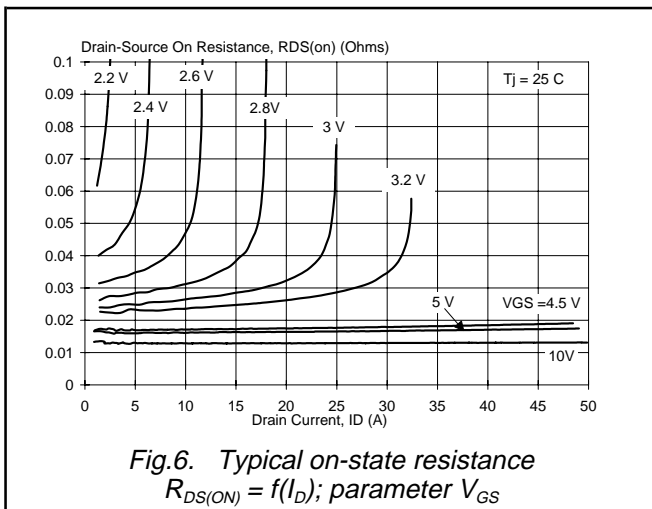
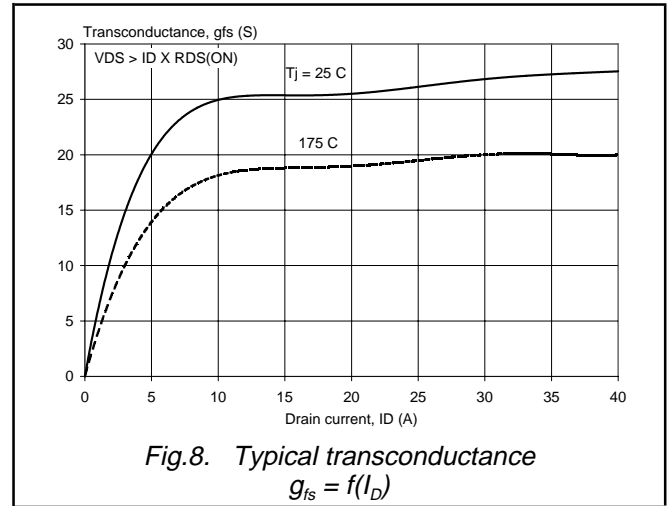
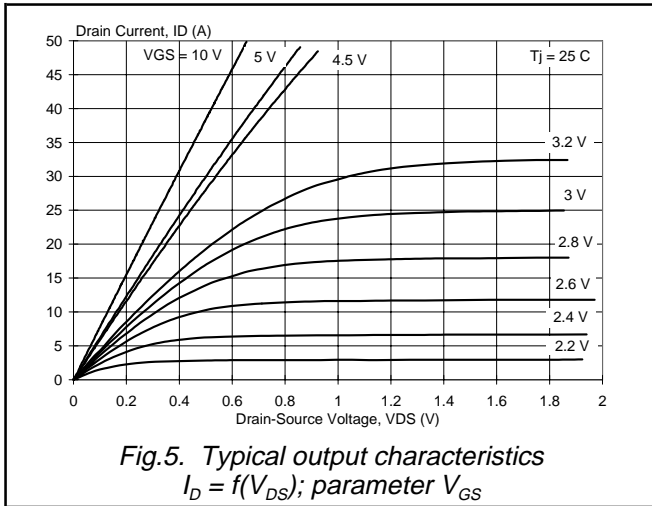
T_j = 25°C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _S	Continuous source current (body diode)		-	-	48	A
I _{SM}	Pulsed source current (body diode)		-	-	180	A
V _{SD}	Diode forward voltage	I _F = 25 A; V _{GS} = 0 V I _F = 40 A; V _{GS} = 0 V	-	0.95 1.05	1.2 -	V
t _{rr}	Reverse recovery time	I _F = 20 A; -di _F /dt = 100 A/μs; V _{GS} = 0 V; V _R = 25 V	-	100	-	ns
Q _{rr}	Reverse recovery charge		-	0.13	-	μC



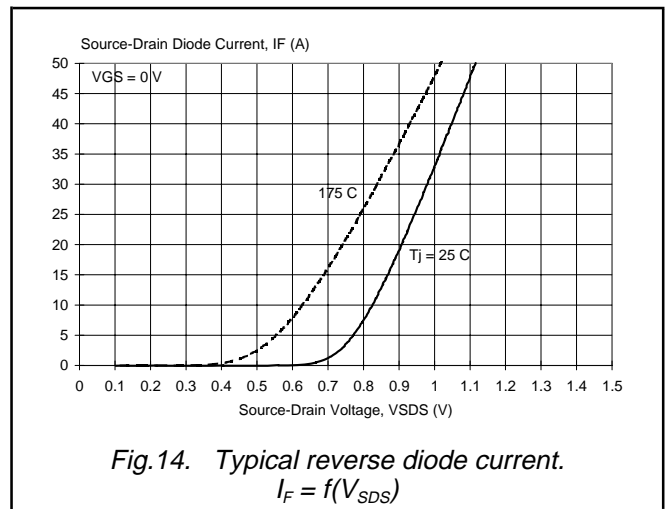
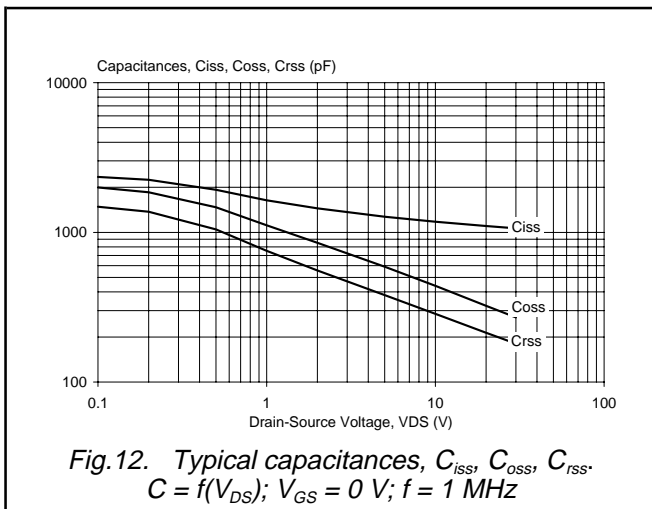
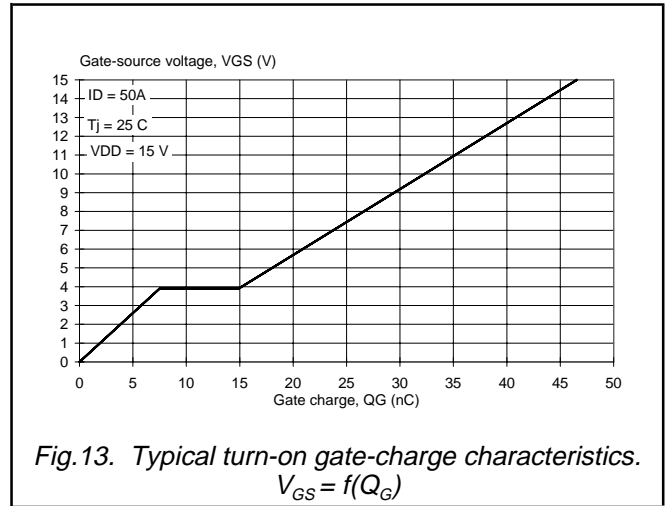
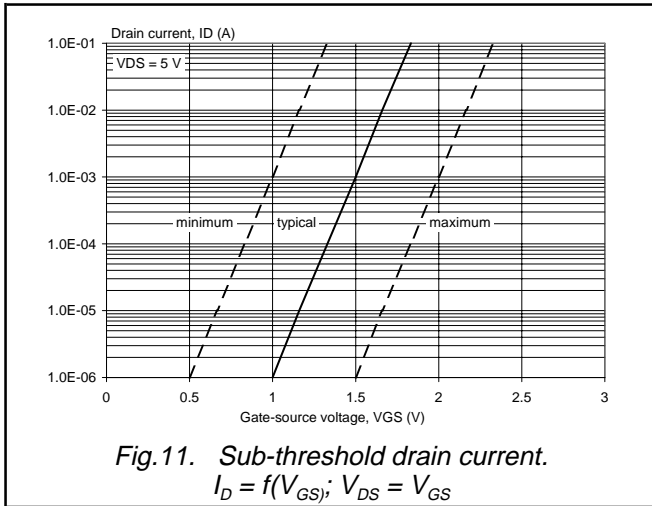
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MECHANICAL DATA

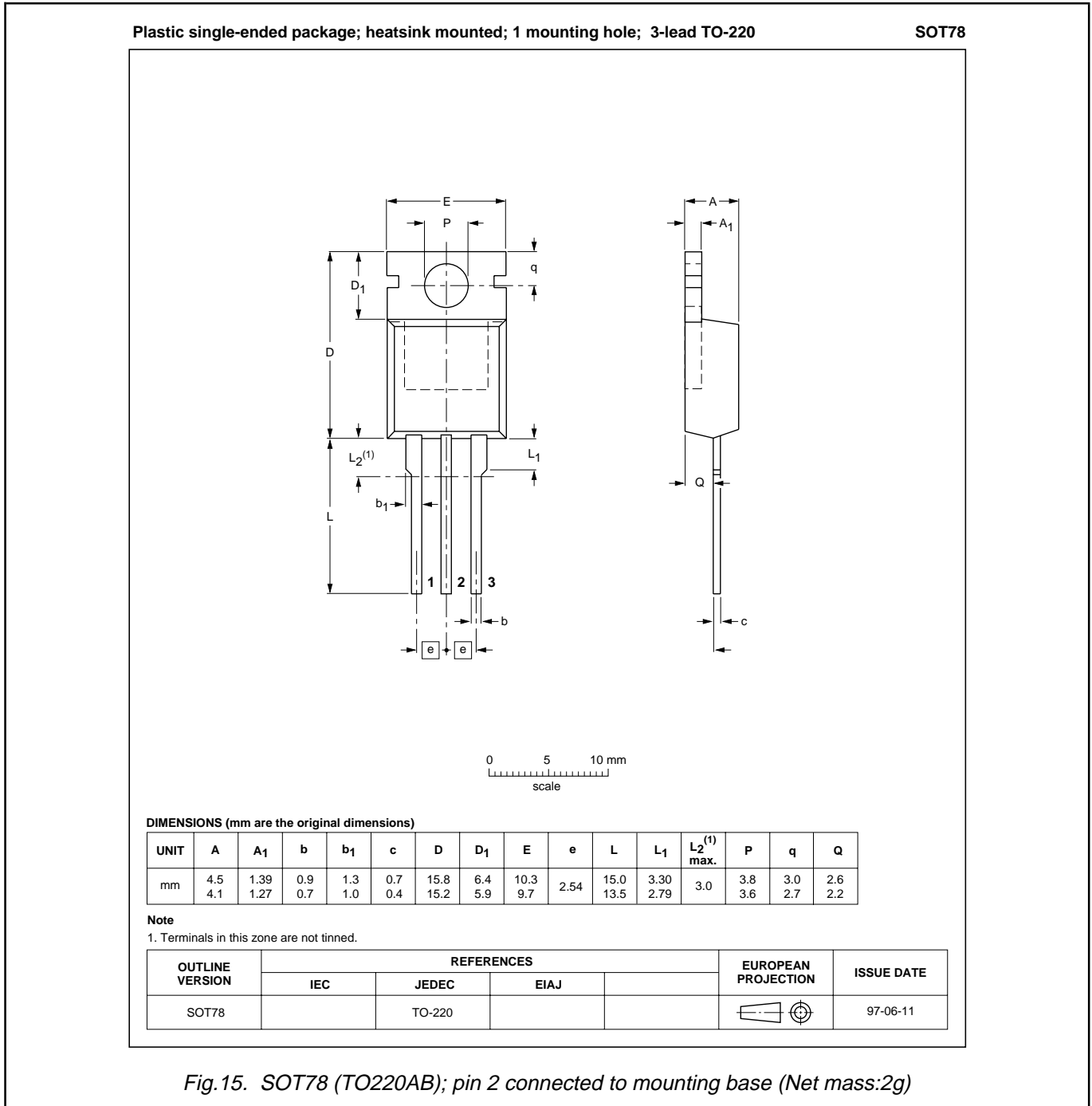


Fig. 15. SOT78 (TO220AB); pin 2 connected to mounting base (Net mass:2g)

Notes

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to mounting instructions for SOT78 (TO220AB) package.
3. Epoxy meets UL94 V0 at 1/8".

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MECHANICAL DATA

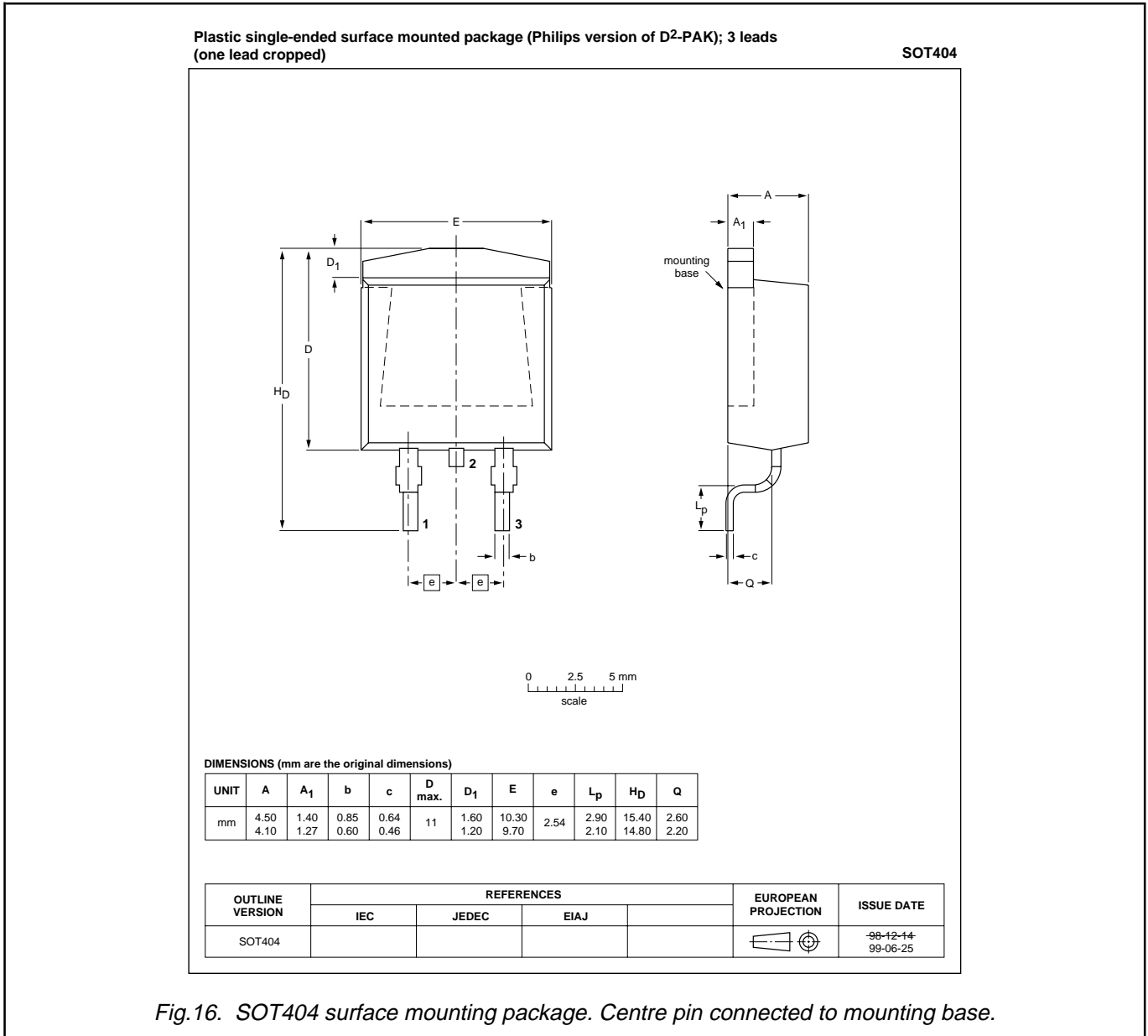


Fig.16. SOT404 surface mounting package. Centre pin connected to mounting base.

Notes

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
3. Epoxy meets UL94 V0 at 1/8".

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MOUNTING INSTRUCTIONS

Dimensions in mm

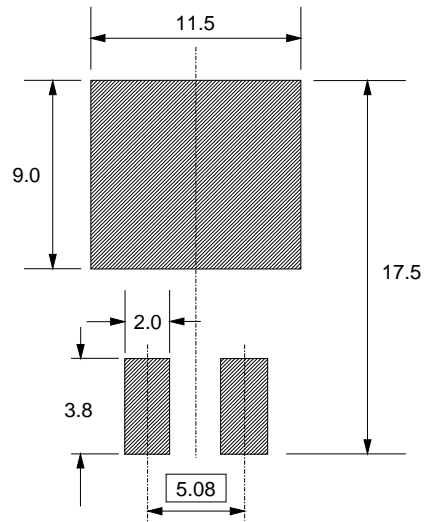


Fig.17. SOT404 : soldering pattern for surface mounting.

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MECHANICAL DATA

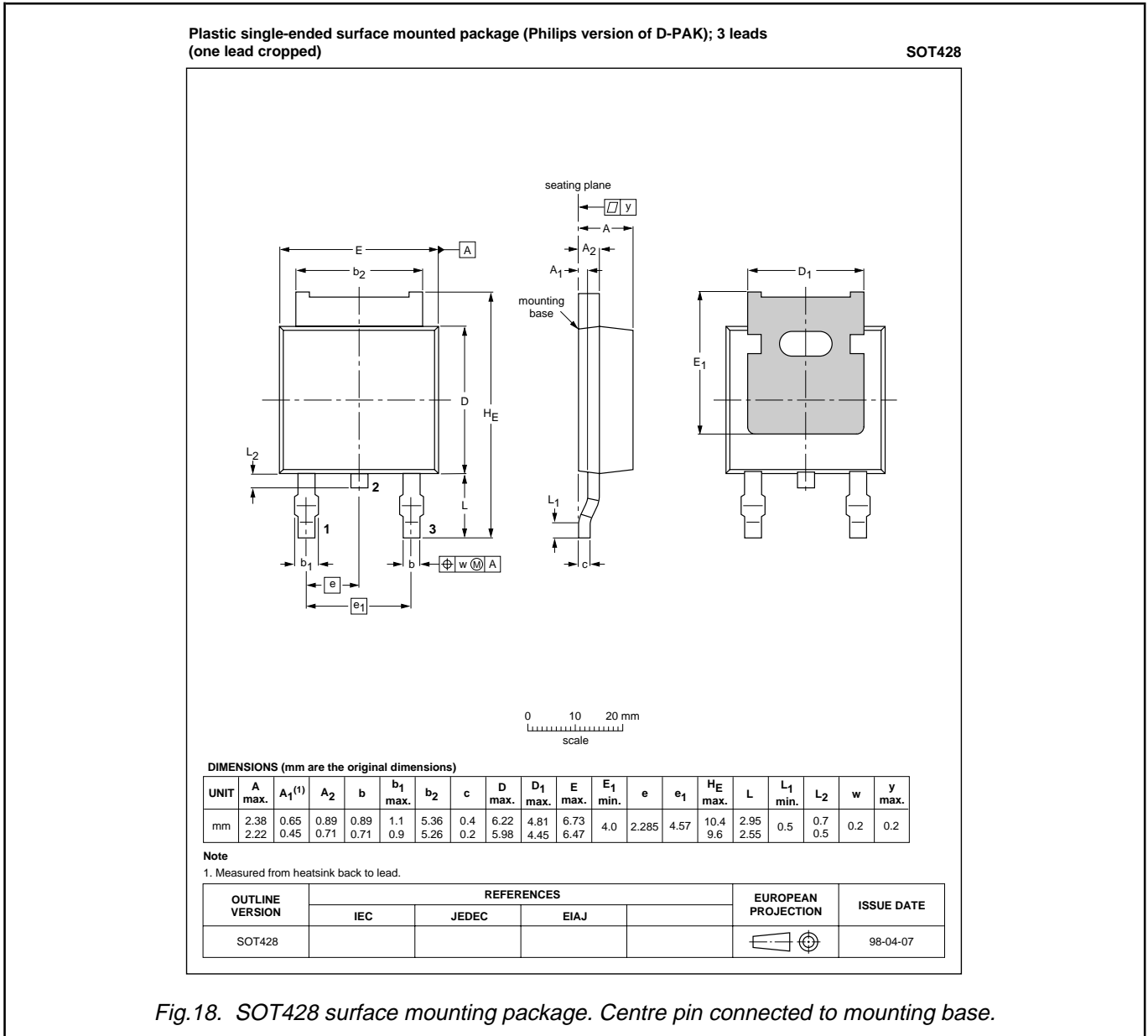


Fig.18. SOT428 surface mounting package. Centre pin connected to mounting base.

Notes

1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
3. Epoxy meets UL94 V0 at 1/8".

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MOUNTING INSTRUCTIONS

Dimensions in mm

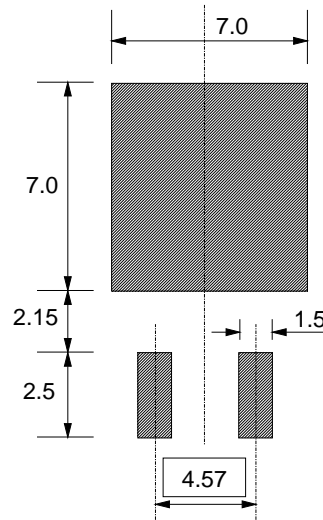


Fig.19. SOT428 : soldering pattern for surface mounting.

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DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	
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